



Intel Architecture 2S Server Tioga Pass - Performance and Power Optimization

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Agenda

Tioga Pass Feature Overview

Intel Xeon Scalable Processor Family (Purley/Skylake) Performance and Power

Optimize Power & Performance for FB workload

Call to Action

Overview

- Half width 2S system in ORv2
- Intel Xeon Scalable Processor (Purley/Skylake)
 CPUs up to 165W TDP
- 12 memory channels @ 2666Mhz
- Single sided/Double sided memory SKUs
- 2x PCle Gen 3 x16 slots via riser
- OCP NIC 2.0 support: 25G to 100G
- Support Intel KR Mezz Card
- Support for Intel At Scale Debug
- Support for OCP LCD debug card



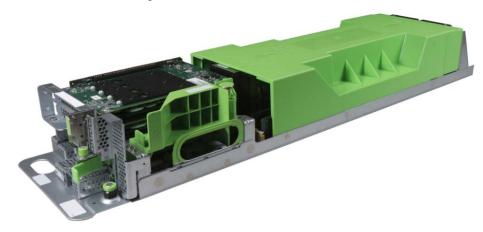


Xeon Scalable Processor Performance & Power

- Performance and Power optimizations possible Xeon Scalable Processor (Purley/Skylake)
- Within the 165W TDP maximum possible CPU SKU:
- SPECint_rate: SKX 39% improvement over BDW with just 14% higher TDP SpecPower: SKX 67% performance improvement over BDW with just 14% higher TDP SKX CPU SpecPower performance per Watt: 46.5% improvement over BDW

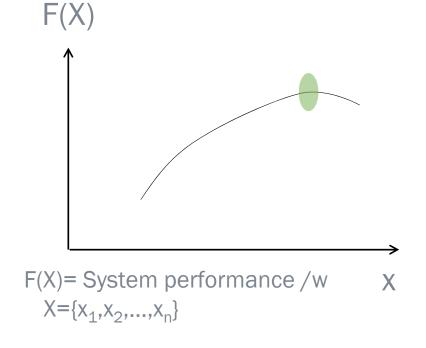
NOTE

- 1. Performance estimates were obtained prior to implementation of recent software patches and firmware updates intended to address exploits referred to as "Spectre" and "Meltdown." Implementation of these updates may make these results inapplicable to your device or system.
- 2. Results based on Intel measurements and are provided for informational purposes only. Any difference in system hardware or software design or configuration may affect actual performance. Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests, such as SYSmark and MobileMark, are measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary. You should consult other information and performance tests to assist you in fully evaluating your contemplated purchases, including the performance of that product when combined with other products.
- For more information go to http://www.intel.com/performance/datacenter.
- 3. Configurations: Shown in backup slides



Optimize Power & Performance for FB workload

In search of best efficiency for scaling out



	Parameters to explore across different SKUs		
X_1	TDP		
X_2	Core Count		
X_3	Frequency		
X_4	Tcase		
X ₅	Others		

Summary

- Check out the Tioga Pass hardware
 - Facebook
 - Intel
 - Inspur
 - Quanta
 - Wiwynn
- Learn more about the <u>Tioga Pass specification</u>
- Learn more about Intel Xeon Scalable Processor
- Come visit the Intel booth!

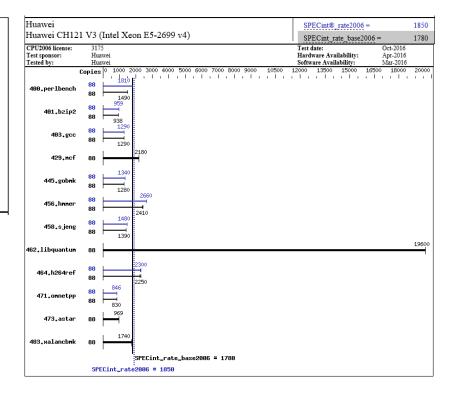
QUESTIONS

Intel E5-2699 v4 SPEC Detail

Hardware Software Intel Xeon E5-2699 v4 Red Hat Enterprise Linux Server release 7.2 CPU Name: Operating System: CPU Characteristics: Intel Turbo Boost Technology up to 3.60 GHz 3.10.0-327.el7.x86 64 CPU MHz: Compiler: C/C++: Version 16.0.0.101 of Intel C++ Studio XE FPU: Integrated for Linux CPU(s) enabled: 44 cores, 2 chips, 22 cores/chip, 2 threads/core Auto Parallel: No CPU(s) orderable: File System: xfs Primary Cache: 32 KB I + 32 KB D on chip per core System State: Run level 3 (multi-user) Secondary Cache: 256 KB I+D on chip per core Base Pointers: 32-bit L3 Cache: 55 MB I+D on chip per chip Peak Pointers: 32/64-bit Other Cache: Other Software: Microquill SmartHeap V10.2 Memory: 256 GB (16 x 16 GB 2Rx8 PC4-2400T-R) Disk Subsystem: 1 x 1000 GB SATA, 7200 RPM

Other Hardware:

None



Source: http://spec.org/cpu2006/results/res2016q4/cpu2006-20161020-44646.html

Intel 8176 SPEC Detail

Hardware

CPU Name: Intel Xeon Platinum 8176

CPU Characteristics: Intel Turbo Boost Technology up to 3.80 GHz

CPU MHz: 2100 FPU: Integrated

CPU(s) enabled: 56 cores, 2 chips, 28 cores/chip, 2 threads/core

CPU(s) orderable: 1,2 chip

Primary Cache: 32 KB I + 32 KB D on chip per core
Secondary Cache: 1 MB I+D on chip per core
L3 Cache: 38.5 MB I+D on chip per chip

Other Cache: Non

Memory: 384 GB (24 x 16 GB 2Rx4 PC4-2666V-R)

Disk Subsystem: 1 x 600 GB SAS 10K RPM

Other Hardware: Nor

Software

Operating System: SUSE Linux Enterprise Server 12 SP2

4.4.21-69-default

Compiler: C/C++: Version 17.0.3.191 of Intel C/C++

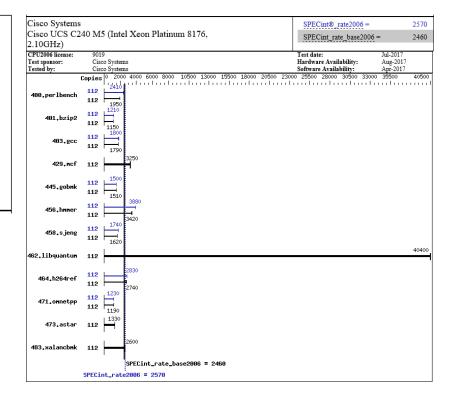
Compiler for Linux

Auto Parallel: Yes File System: xfs

System State: Run level 3 (multi-user)

Base Pointers: 32-bit Peak Pointers: 32/64-bit

Other Software: Microquill SmartHeap V10.2



Source: http://spec.org/cpu2006/results/res2017q3/cpu2006-20170725-47928.html

Intel E5-2699 v4 SPEC Detail

Hardware			Software		
Hardware Vendor:		Power	Enabled ("Balanced Performance" power plan)		
	NF5280 M4	Management:			
Form Factor:		Operating System (OS):	Microsoft Windows Servers 2012 R2 Standard		
	Intel Xeon E5-2699 v4		Version 6.3.9600 Build 9600		
	22-Core, 2.20GHz, 55MB L3 Cache	Filesystem:			
CPU Frequency (MHz):					
CPU(s) Enabled:	44 cores, 2 chips, 22 cores/chip		Oracle Corporation Oracle Java HotSpotTM\64-Bit Server VM(build 24.80-b11.mixed mode) version 1.7.0 80		
Hardware Threads:	88 (2 / core)	JVW Version:			
CPU(s) Orderable:	1,2 chips	IVM Command	-server -Xmn11g -Xms13g -Xmx13g -XX:SurvivorRatio=60 -XX:TargetSurvivorRatio=90 -XX:AllocatePrefetchDistance=256 -XX:AllocatePrefetchLines=4 -XX:LoopUnrollLimit=45 -XX:InitialTenuringThreshold=12 -XX:MaxTenuringThreshold=15 -XX:ParallelGCThreads=22		
Primary Cache:	32 KB I + 32 KB D on chip per core	line Options:	-XX.InlineSmallCode=3900 -XX.MaxInlineSize=270 -XX.FreqInlineSize=2500-XX.*AggressiveOpts -XX.*+UseParalleOldGC		
Secondary Cache:	256 KB I+D on chip per core		-XX:-UseAdaptiveSizePolicy		
Tertiary Cache:	55 MB I+D on chip per chip	JVM Affinity:	start /NODE [0,1,2,3] /affinity 0x3FFFFF		
Other Cache:	None	JVM Instances:			
Memory Amount (GB):	128	JVM Initial Heap	13000		
# and size of DIMM:	8 x 16 GB	(MB):			
Memory Details:	16 GB 2Rx8 PC4-2400N ECC; slots CHA0, CHB0, CHC0, CHD0, CHE0, CHF0, CHG0, CHH0 populated	JVM Maximum Heap (MB):	13000		
Power Supply Quantity and Rating (W):	1 x 800	Heap (MB):			
Power Supply Details:	Delta DPS-800AB-9X P/N:V07LP040000000F	JVM Address Bits:			
Disk Drive:	Intel SSD DC S3500 Series 6Gb/s 80G PN:ZMHD1000018	Boot Firmware Version:	4.1.8		
Disk Controller:	Integrated SATA Controller				
# and type of Network Interface Cards (NICs) Installed:	1 x Intel I350 OnBoard LAN	Management Firmware Version:	4.15		
NICs Enabled in Firmware / OS / Connected:	2/2/1	Workload Version:	SSJ 1.2.10		
Network Speed (Mbit):	1000	Director Location:			
Keyboard:	None	Other Software:			
Mouse:	None				
Monitor:	None				
Optical Drives:	No				
Other Hardware:	None				

Performance		Power	Performance to Power Ratio	
Target Load	Actual Load	ssj_ops	Average Active Power (W)	Performance to Power Ratio
100%	99.7%	3,561,599	245	14,567
90%	89.9%	3,210,954	221	14,551
80%	80.1%	2,859,402	191	14,951
70%	70.1%	2,504,652	171	14,637
60%	59.9%	2,138,538	156	13,676
50%	49.9%	1,783,222	144	12,362
40%	40.0%	1,427,593	130	10,988
30%	29.9%	1,068,982	113	9,483
20%	20.0%	713,846	97.5	7,325
10%	10.0%	357,111	82.1	4,349
	Active Idle	0	45.7	0
∑ssj_ops / ∑power =				12,296

Source: http://spec.org/power_ssj2008/results/res2017q3/power_ssj2008-20170807-00775.html

Intel 8176 SPEC Detail

Hardware		Software		
Hardware Vendor:	Huawei Technologies Co., Ltd	Power	Balanced (recommended) Mode enabled in OS	
Model:	Fusion Server 2288H V5	Management:	Balanced (recommended) Mode enabled in OS	
Form Factor:	20	Operating	Microsoft Windows Server 2012 R2 Datacenter	
CPU Name:	Intel Xeon Platinum 8176	System (OS):		
CPU Characteristics:	28-Core, 2.1GHz, 38.5MB L3 Cache (Intel Turbo Boost Technology up to 2.8GHz)	OS Version:		
CPU Frequency (MHz):	2100	Filesystem:		
CPU(s) Enabled:	56 cores, 2 chips, 28 cores/chip		Oracle Corporation	
Hardware Threads:	112 (2 / core)		Oracle Java HotSpot(TM) 64-Bit Server VM (build 24.80-b11, mixed mode), version 1.7.0_80	
CPU(s) Orderable:	1,2 chips	JVM Command line	-server -Xmn1300m -Xms1550m -XXxx1550m -XXx:SurvivorRatio=1 -XX:TargetSurvivorRatio=99 -XX:ParallelGCThreads=2 -XX:AllocatePrefetchDistance=256 -XX:AllocatePrefetchLines=4 -XX:LoopUnrollLimit=45 -XX:InitialTenuringThreshold=12 -XX:MaxTenuringThreshold=15	
Primary Cache:	32 KB I + 32 KB D on chip per core	Ontions	-AX-allocate relections and experience and a second relection of the second relection of the second relection of the second relationship of the second relation relation of the second relation relation relation relationship of the second relation relation relation relationship of the second relation relationship of the second relation relationship of the second relation relatio	
Secondary Cache:	1 MB I+D on chip per core	Орионо	start /NODE [0,2,] /AFFINITY	
Tertiary Cache:	39424 KB I+D on chip per chip	JVM Affinity:	[3,C,30,C,0,C000,30000,C0000,30000000,C0000000,30000000,C00000000	
Other Cache:	None		[3, C, 30, 3000, C000, 30000, C0000, 30000000, C00000000, 3000000000, 3000000000, C0000000000	
Memory Amount (GB):	192	JVM	56	
# and size of DIMM:	12 x 16 GB	Instances:		
Memory Details:	12 x 16GB 2Rx8 PC4-2666V ECC RDIMM;slots DIMM000, DIMM010, DIMM020, DIMM030, DIMM040, DIMM050, DIMM100, DIMM110, DIMM120, DIMM130, DIMM140, and DIMM150 populated	JVM Initial Heap (MB):	1550	
Power Supply Quantity and Rating (W):	1×550	JVM Maximum Heap (MB):	1550	
Power Supply Details:	Huawei P/N 02131255	JVM Address		
Disk Drive:	1 x 240GB SSD 2.5" SATA Huawei P/N 02311HGX	Bits:	64	
Disk Controller:	Integrated SATA controller	Boot Firmware		
# and type of Network Interface Cards (NICs) Installed:	1 x Dual-port Intel X722 Gigabit Ethernet controller	Version: Management	0.20	
NICs Enabled in Firmware / OS / Connected:	2/2/1	Firmware Version:	2.53	
Network Speed (Mbit):	1000	Workload	SSJ 1.2.10	
Keyboard:	None	Version:		
Mouse:	None	Director	Controller	
Monitor:	None	Location:		
Optical Drives:	No	Other Software:	None	
Other Hardware:	None	Joitware.		

Performance		Power	Performance to Power Ratio	
Target Load	Actual Load	ssj_ops	Average Active Power (W)	Performance to Power Ratio
100%	99.9%	5,941,377	461	12,882
90%	90.2%	5,362,581	381	14,083
80%	79.9%	4,753,465	313	15,181
70%	70.0%	4,160,796	277	15,029
60%	60.1%	3,573,477	233	15,362
50%	49.9%	2,969,633	201	14,739
40%	39.9%	2,374,390	182	13,065
30%	29.9%	1,778,877	162	10,985
20%	19.9%	1,186,091	142	8,375
10%	10.0%	596,165	120	4,957
Active Idle 0		49.6	0	
∑ssj_ops / ∑power =				12,968

Source: http://spec.org/power_ssj2008/results/res2017q3/power_ssj2008-20170621-00759.html

Notes and Disclaimers

Intel technologies' features and benefits depend on system configuration and may require enabled hardware, software or service activation. Performance varies depending on system configuration.

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Benchmark results were obtained prior to implementation of recent software patches and firmware updates intended to address exploits referred to as "Spectre" and "Meltdown." Implementation of these updates may make these results inapplicable to your device or system.

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